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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DÖCKET NO.	CONFIRMATION NO.
09/217,401	12/21/1998		KENZO ISHIDA	884.088US1	8371
21186	7590	11/06/2003		EXAM	INER
SCHWEGN	MAN, LU	INDBERG, WOE	TRAN, T	TRAN, THANH Y	
P.O. BOX 29	938				
MINNEAPO	LIS, MN	55402		ART UNIT	PAPER NUMBER
,				2827	

DATE MAILED: 11/06/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

,		Application No.	Applic	cant(s) /\footnote{T}			
		09/217,401	ISHID	A ET AL.			
	Office Action Summary	Examiner	Art Ur	ıit			
		Thanh Y. Tran	2841				
Period fo	The MAILING DATE of this communication apports. The ply	pears on the cove	sheet with the correspo	ondence address			
THE I - External after - If the - If NO - Failur - Any r	ORTENED STATUTORY PERIOD FOR REPL MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.1 SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period re to reply within the set or extended period for reply will, by statute eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, howe ly within the statutory mir will apply and will expire a, cause the application to	over, may a reply be timely filed imum of thirty (30) days will be or SIX (6) MONTHS from the mailin b become ABANDONED (35 U.S	onsidered timely. g date of this communication. C. § 133).			
1)🖂	Responsive to communication(s) filed on 21.	<i>July 2003</i> .					
2a)□	This action is FINAL. 2b)⊠ Th	nis action is non-fi	nal.				
3)□ Dispositi	Since this application is in condition for allow closed in accordance with the practice under on of Claims						
4) 🖂	Claim(s) 30-56 is/are pending in the application	on.					
	4a) Of the above claim(s) is/are withdra		ation.				
	Claim(s) is/are allowed.						
·	Claim(s) 30-38 and 41-56 is/are rejected.						
·	Claim(s) 39 and 40 is/are objected to.						
8)	Claim(s) are subject to restriction and/o	or election require	ment.				
	on Papers	·					
9) 🗌 .	The specification is objected to by the Examine	er.					
10) 🔲 🤄	The drawing(s) filed on is/are: a)☐ acce	pted or b)⊡ object	ed to by the Examiner.				
	Applicant may not request that any objection to th	e drawing(s) be hel	d in abeyance. See 37 Cl	FR 1.85(a).			
11) 🔲	The proposed drawing correction filed on	_ is: a)∏ approve	ed b) disapproved by	the Examiner.			
	If approved, corrected drawings are required in re	ply to this Office ac	ion.				
12)	The oath or declaration is objected to by the Ex	caminer.					
Priority u	ınder 35 U.S.C. §§ 119 and 120						
13) 🗌	Acknowledgment is made of a claim for foreign	n priority under 35	U.S.C. § 119(a)-(d) or	(f) .			
a)[☐ All b)☐ Some * c)☐ None of:						
	1. Certified copies of the priority document	ts have been rece	ived.				
	2. Certified copies of the priority document	ts have been rece	ived in Application No.	•			
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 							
14)∐ A	cknowledgment is made of a claim for domesti	ic priority under 3	5 U.S.C. § 119(e) (to a	provisional application).			
	☐ The translation of the foreign language pro Acknowledgment is made of a claim for domest			121.			
Attachment	r(s)						
2) Notic	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449) Paper No(s) _	4)	Interview Summary (PTO-41 Notice of Informal Patent Ap Other:				
J.S. Patent and Tr PTOL-326 (R		ction Summary		Part of Paper No. 24			

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DETAILED ACTION

Applicant's arguments with respect to claims 30-56 have been considered but are most in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 30-38 and 41-47 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kazama (U.S. 6,174,172) in view of Kulesza et al (U.S. 5,611,140).

With respect to claims 30, 32, 34 and 35, Kazama discloses a mounting socket (2, Fig. 14), comprising a body (2) having first and second sides, and having a plurality of vias extending from a first side to a second side (see Figs. 14, 21, 22); a plurality of conductive terminals (33, Fig. 14) within the vias (8), each terminal (33) including a spring extending through one of the vias and adapted to exert a return force when compressed (see col. 4, lines 3-14), solder material in contact with the spring and with the one via (8) (see col. 5, lines 58-65; and col. 6, lines 15-26).

Kazama does not teach a mounting socket comprising a conductive polymer is deformable when the spring is compressed and in contact with the spring and with the one via; the conductive polymer fills the vias from side to side and end to end. Kulesza et al teaches a mounting socket/layer (56, Figs. 11-12) comprising a conductive polymer (30) provided in the one via (58) (see Fig. 11, col. 5, lines 17-52). Therefore, it would have been obvious to a person having ordinary skill in the art at the time the invention

was made to modify the socket of Kazama by replacing the solder material with a conductive polymer provided in the one via as taught by Kulesza et al for retaining the spring within the via/hole and also increasing resilient properties of the terminals.

With respect to claim 31, Kazama discloses a mounting socket (2, Fig. 14) where the spring is a coil (see Fig. 14, element 33, col. 6, lines 15-58).

With respect to claim 33, figure 14 of Kazama shows that the vias have a constant width.

With respect to claim 36, figure 14 of Kazama shows that the terminals (33) extend beyond the first and second sides of the body (2).

With respect to claim 37, Kazama does not teach that the terminals are solderless. The Examiner takes Official Notice that it is known to provide the terminals are solderless in the vias of the socket. Thus it would have been obvious to a person having ordinary skill in the art at the time the invention was made to modify the device of Kazama by including the solderless terminals in the vias for the purpose of intended use.

With respect to claim 38, figure 8(b) of Kazama shows that a first adhesive layer (5) affixed to the first side of the body (2).

With respect to claim 41, figure 8(b) of Kazama further shows adhesive layer (see "adhesive layer" as labeled in figure 8 b) affixed to the second side of the body (2).

With respect to claim 42, Kazama discloses a circuit assembly (Figs. 14, 22), comprising a substrate (6) having a plurality of lands (7) thereon; a socket body (2) having a first side in contact with the substrate (6), and having an opposite side; a plurality of vias (8) extending from the first side to the second side; a plurality of conductive terminals (33) within the vias (8) and contacting the lands (7), each terminal

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(33) including a spring extending through one of the vias (8) and adapted to exert a return force when compressed. The same reasoning applies to claim 42 regarding the limitation of a conductive polymer in contact with the spring and with the one via as discussed above in claim 30.

With respect to claim 43, Kazama discloses a circuit assembly (Figs. 14, 22) wherein the conductive terminals (33) inherently exert a force upon the lands (7) when compressed.

With respect to claim 44, figure 8(b) of Kazama further shows a circuit assembly comprising an adhesive layer (as labeled in figure 8 b) bonding the socket body (2) to the substrate (6).

With respect to claim 45, figure 14 of Kazama further shows comprising an integrated circuit (semiconductor device) (4) coupled to the substrate (6).

With respect to claims 46 and 47, Kazama does not teach the circuit assembly comprising a circuit board contacting the opposite side of the socket body, and another adhesive layer on the opposite side of the socket body bonding it to the circuit board. The Examiner takes Official Notice that it is known to provide the circuit assembly with a circuit board bonded to the opposite side of the socket. Thus it would have been obvious to a person having ordinary skill in the art at the time the invention was made to modify the circuit assembly of Kazama by including a circuit board for use in high density IC package for performing electrical functions.

Method claims 48-56 are deemed to be inherent upon the references of Kazama and Kulesza et al as applied above in claims 30-38 and 41-47.

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Allowable Subject Matter

3. Claims 39-40 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Contact Information

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thanh Y. Tran whose telephone number is (703) 305-4757. The examiner can normally be reached on Monday through Thursday and every other Fridays.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David Martin, can be reached on (703) 308-3121. The fax phone number for the organization where this application or proceeding is assigned is (703) 305-3431.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

TYT

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